Appl. No. 10/002,100 Amdt. Dated September 22, 2003 Reply to Office Action of June 23, 2003 Attorney Docket No. 81839.0106 Customer No. 26021

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Jun KISHIMOTO

Serial No: 10/002,100 Confirmation No.: 3823

Filed:

November 14, 2001

For:

SEMICONDUCTOR WAFER AND

METHOD FOR FABRICATION

THEREOF

AMENDMENT

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of June 23, 2003, please amend the above-identified application as follows:

Amendments to the claims are reflected in the Listing Of Claims which begins on page 2 of this paper.

Amendments to the Drawings begin on page 3 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 4 of this paper.

Art Unit: 1765

Examiner: Duy Vu Nguyen Deo

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:

10:

Mail Stop Non-Fee Amendment Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450 September 22, 2003

Date of Deposit

John P. Schenacher, Reg. No. 23,009

de V. Scherlade

Date